



**SD560B STANDARD RECTIFIER**

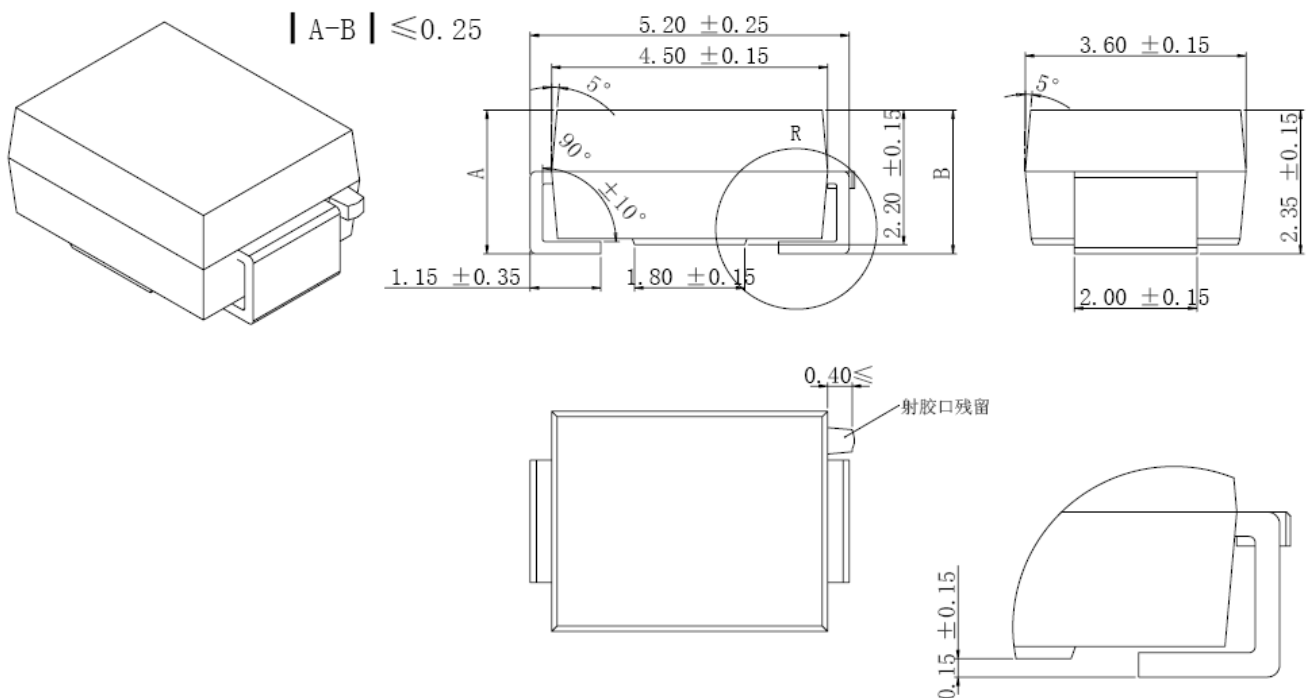
**Features:**

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop
- Surge Overload Rating to 200A Peak
- Low Power Loss
- Built Strain Relief
- Plastic Case Material has UL Flammability Classification Rating 94V-0
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

**Mechanical data:**

- Case: Molded Plastic
- Terminals: Solder Plated , Solderable Per MIL-STD 750 ,Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Weight: 0.68 grams(Approx)

**Mechanical Dimensions: In mm**

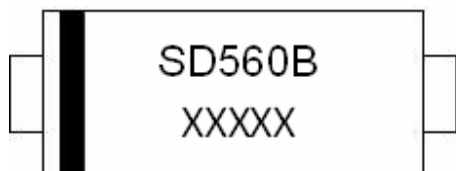


**SMB**



**Marking Diagram:**

Where XXXXX is YYWWL



SD560B = Part Name  
YY = Year  
WW = Week  
L = Lot Number

**Cautions:** Molding resin  
Epoxy resin UL:94V-0

**Ordering Information**

Device	Package	Shipping
SD560B	SMB (Pb-Free)	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.



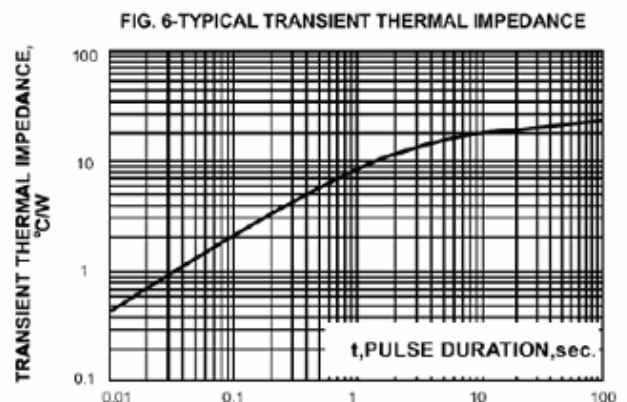
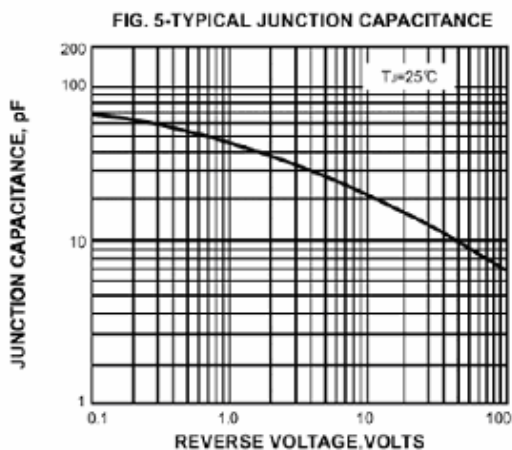
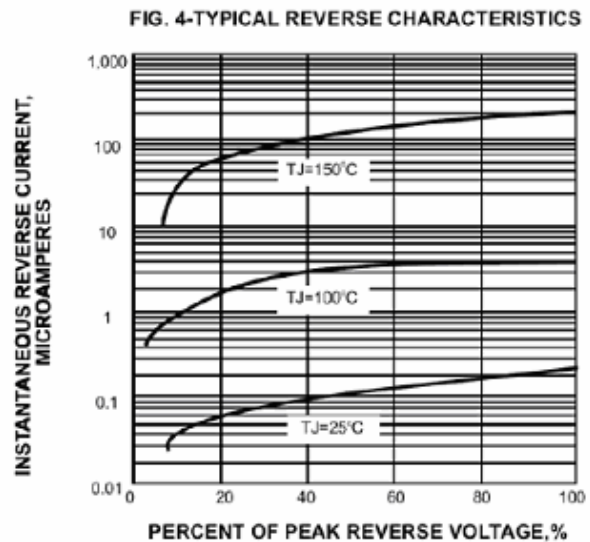
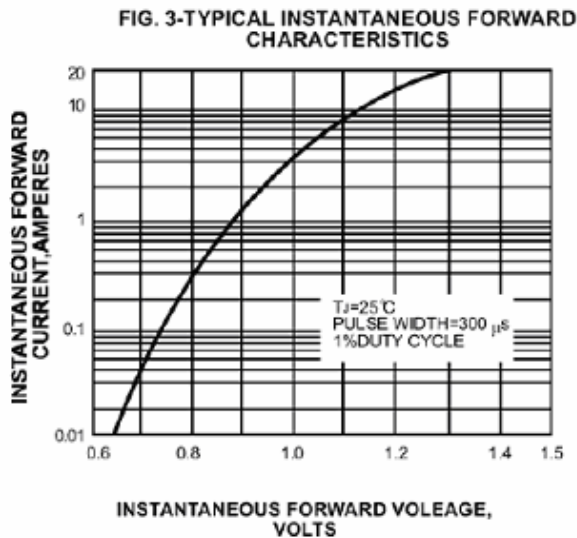
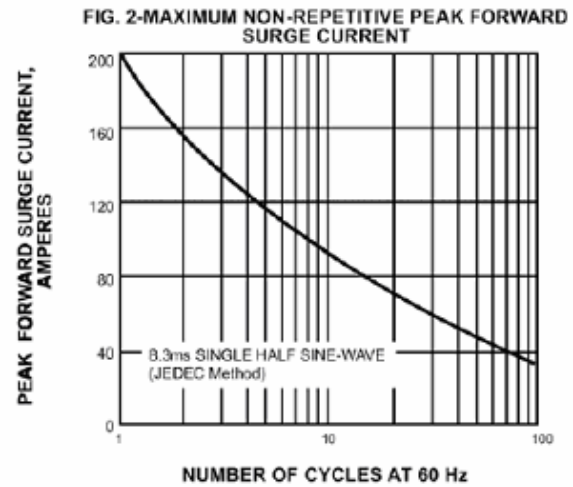
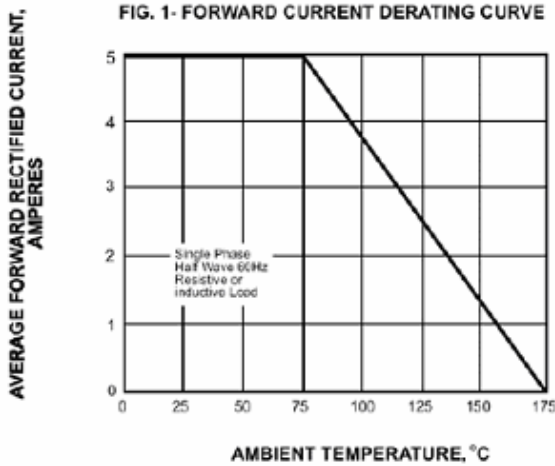
**Maximum Ratings and Electrical Characteristics** @ $T_A=25^{\circ}\text{C}$  unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	SD560B	Unit
Maximum Peak Repetitive Reverse Voltage Maximum DC Blocking Voltage	$V_{RRM}$ $V_R$	600	V
Maximum RMS Voltage	$V_{RMS}$	420	
Maximum Average Forward Rectified Current 0.375"(9.5mm) Lead Length @ $T_A = 75^{\circ}\text{C}$	$I_{(AV)}$	5.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	200	A
$I^2 t$ Rating for fusing ( $t < 8.3\text{ms}$ )	$I^2 t$	166	$\text{A}^2 \text{S}$
Maximum Instantaneous Forward Voltage @ $I_F = 5.0\text{A}$	$V_F$	1.2	V
Maximum DC Reverse Current At Rated DC Blocking Voltage @ $T_A = 25^{\circ}\text{C}$ @ $T_A = 100^{\circ}\text{C}$	$I_R$	9.0 170	$\mu\text{A}$
Typical Junction Capacitance (Note 1)	$C_j$	50	pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	20	$^{\circ}\text{C}/\text{W}$
Operating Storage Temperature Range	$T_{STG}$	-65 to +175	$^{\circ}\text{C}$
Operating Junction Temperature	$T_J$	-65 to +175	$^{\circ}\text{C}$
Case Style	SMB		

Note: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

2. Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, P.C.B. mounted





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